S8PG, S8PJ, S8PK, S8PM

Vishay General Semiconductor

High Current Density Surface-Mount Glass Passivated Rectifiers



Anode 1 Anode 2

www.vishay.com

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)} 8 A					
V _{RRM}	400 V, 600 V, 800 V, 1000 V				
I _{FSM}	230 A				
I _R	5 µA				
V_F at $I_F = 8 A$	0.87 V				
T _J max.	150 °C				
Package	SMPC (TO-277A)				
Circuit configuration	Single				

FEATURES

- Very low profile typical height of 1.1 mm
- · Ideal for automated placement
- · Glass passivated pellet chip junction
- Low forward voltage drop
- · High surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer, and telecommunication.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102 M3 suffix meets JESD 201 class 2 whisker test

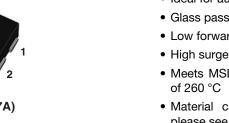
MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	SYMBOL	S8PG	S8PJ	S8PK	S8PM	UNIT	
Device marking code		S8PG	S8PJ	S8PK	S8PM		
Max. repetitive peak reverse voltage	V _{RRM}	400	600	800	1000	V	
Average forward everent	I _{F(AV)} ⁽¹⁾	8					
Average forward current	I _{F(AV)} ⁽²⁾		А				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	230				А	
Operating junction and storage temperature range	T _J ⁽³⁾ , T _{STG}	-55 to +150			°C		

Notes

⁽¹⁾ Mounted on 3 cm x 3 cm aluminum pad area

⁽²⁾ Free air mounted on recommended pad area

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_1 < 1/R_{0.IA}$





RoHS COMPLIANT HALOGEN FREE



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ELECTRICAL CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 4 A	$T_1 = 25 ^{\circ}\text{C}$	V _F ⁽¹⁾	0.91	-	V	
	I _F = 8 A			0.97	1.10		
	$I_F = 4 A$	T _J = 125 °C		0.79	-		
	I _F = 8 A			0.87	0.95		
Reverse current	Rated V _B	$d V_R \qquad \frac{T_J = 25 \ ^\circ C}{T_J = 125 \ ^\circ C}$	I _R ⁽²⁾	-	5	μA	
	naleu v _R			92	250		
Max. reverse recovery time	I _F = 0.5 A, I _R I _{rr} = 0.25 A	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		5.0	-	μs	
Typical junction capacitance	4.0 V, 1 MHz	4.0 V, 1 MHz		60	-	pF	

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise specified)						
PARAMETER	SYMBOL	S8PG	S8PJ	S8PK	S8PM	UNIT
Typical thermal resistance	R _{0JA} (1)(2)	82				°C/W
	R _{0JM} ⁽³⁾	3.5				0/10

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC® 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
S8PM-M3/H	0.10	Н	1500	7" diameter plastic tape and reel				
S8PM-M3/I	0.10	Ι	6500	13" diameter plastic tape and reel				



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

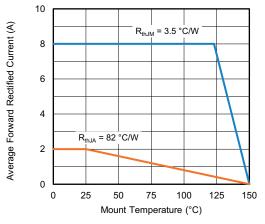


Fig. 1 - Maximum Forward Current Derating Curve

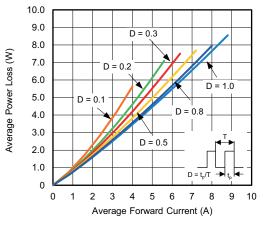


Fig. 2 - Forward Power Loss Characteristics

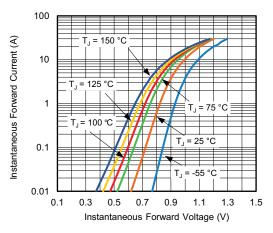


Fig. 3 - Typical Instantaneous Forward Characteristics

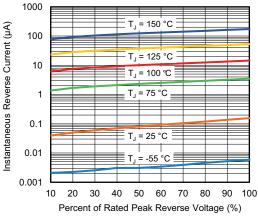


Fig. 4 - Typical Reverse Leakage Characteristics

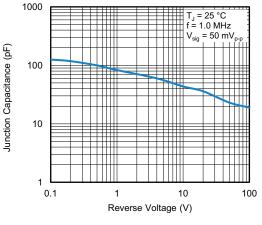


Fig. 5 - Typical Junction Capacitance

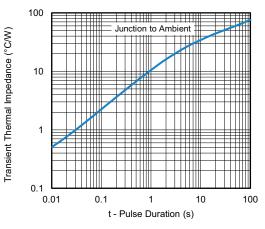


Fig. 6 - Typical Transient Thermal Impedance

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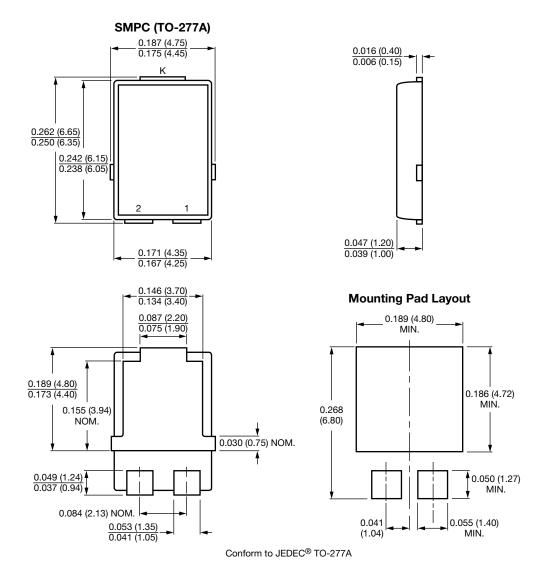
Document Number: 98366

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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